

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT application of:

Takeshi FUKADA et al.

Serial No. 09/904,906

Filed: 07/16/2001

For: GLASS SUBSTRATE ASSEMBLY, SEMICONDUCTOR)

DEVICE AND METHOD OF HEAT-TREATING GLASS SUBSTRATE

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on 1/31/2002.

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents and Trademarks

Washington, D.C. 20231

Sir:

In accordance with the provisions of 37 C.F.R. 1.56 and 37 C.F.R. 1.97-1.99, it is requested that the reference(s) listed on the attached Form PTO-1449 be made of record in the above-identified application. Copies of the references are submitted herewith in accordance with 37 C.F.R. 1.98(a).

US 5,946,561, 6,051,453 and 6,310,362 are being submitted within three (3) months of the filing of this application or entry into the national stage of this application, or before the first Office Action on the merits, whichever is later, therefore no fee or certification is required under 37 C.F.R § 1.97(b).

In accordance with 37 C.F.R. § 1.97(e), it is certified that JP 05-066423 and JP 04-080914 were either (1) first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this information disclosure statement, or (2) were cited in a communication from a foreign patent office in a counterpart foreign patent application and no item of information contained in the information disclosure statement was known to any individual designated in 37 C.F.R. § 1.56(c) more than three months prior to the filing of this information disclosure statement.

US 5,716,857 and 6,008,078 correspond to JP 04-080914. JP 04-080914 was cited in a rejection which was mailed on November 20, 2001 in a counterpart

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Japanese patent application. JP 05-006423 was also cited in a rejection which was mailed on November 27, 2001 in a counterpart Japanese patent application.

The Commissioner is hereby authorized to charge fees under 37 C.F.R. §§1.16, 1.17, 1.20(a), 1.20(b), 1.20(c), and 1.20(d) (except the Issue Fee) which may be required now or hereafter, or credit any overpayment to Deposit Account No. 19-

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Respectfully submitted,

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